

# LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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- 2.7-V and 5-V Performance
- Low-Power Shutdown Mode (LMV324S)
- No Crossover Distortion
- Low Supply Current:
  - LMV321 . . . 130  $\mu$ A Typ
  - LMV358 . . . 210  $\mu$ A Typ
  - LMV324 . . . 410  $\mu$ A Typ
  - LMV324S . . . 410  $\mu$ A Typ
- Rail-to-Rail Output Swing
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 1000-V Charged-Device Model (C101)

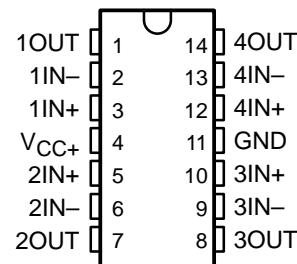
## description/ordering information

The LMOV321, LMOV358, and LMOV324/LMOV324S are single, dual, and quad low-voltage (2.7 V to 5.5 V), operational amplifiers with rail-to-rail output swing. The LMOV324S is a variation of the standard LMOV324 that includes a power-saving shutdown feature that reduces supply current to a maximum of 5  $\mu$ A per channel when the amplifiers are not needed.

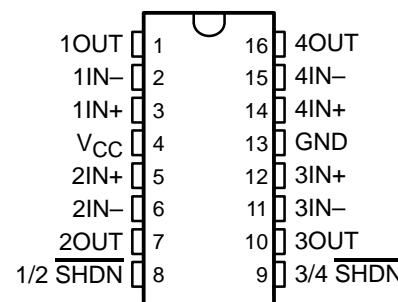
The LMOV321, LMOV358, LMOV324, and LMOV324S are the most cost-effective solutions for applications where low-voltage operation, space saving, and low price are needed. These amplifiers were specifically designed for low-voltage (2.7 V to 5 V) operation, with performance specifications meeting or exceeding the venerable LM358 and LM324 devices that operate from 5 V to 30 V. Additional features of the LMOV3xx devices are a common-mode input voltage range that includes ground, 1-MHz unity-gain bandwidth, and 1-V/ $\mu$ s slew rate.

The LMOV321 is available in the ultra-small DCK (SC-70) package, which is approximately one-half the size of the DBV (SOT-23) package. This package saves space on printed circuit boards and enables the design of small portable electronic devices. It also allows the designer to place the device closer to the signal source to reduce noise pickup and increase signal integrity.

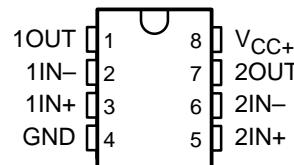
LMV324 . . . D OR PW PACKAGE  
(TOP VIEW)



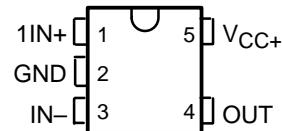
LMV324S . . . D OR PW PACKAGE  
(TOP VIEW)



LMV358 . . . D, DGK, OR PW PACKAGE  
(TOP VIEW)



LMV321 . . . DBV OR DCK PACKAGE  
(TOP VIEW)



PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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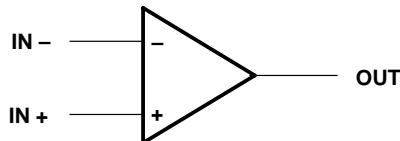
## ORDERING INFORMATION

TA	PACKAGE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING‡
–40°C to 85°C	SOIC (D)	Tube of 50	LMV324ID
		Reel of 2500	LMV324IDR
		Tube of 40	LMV324SID
		Reel of 2500	LMV324SIDR
		Tube of 75	LMV358ID
		Reel of 2500	LMV358IDR
	SC-70 (DCK)	Reel of 3000	LMV321IDCKR
	SOT-23 (DBV)	Reel of 3000	LMV321IDBVR
	TSSOP (PW)	Reel of 2000	LMV324IPWR
			LMV324SIPWR
			LMV358IPWR
	VSSOP (DGK)	Reel of 2500	LMV358IDGKR

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).

‡ DBV/DCK: The actual top-side marking has one additional character that designates the assembly/test site.

## symbol (each amplifier)



# LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage, $V_{CC}$ (see Note 1)	.....	5.5 V
Differential input voltage, $V_{ID}$ (see Note 2)	.....	$\pm 5.5$ V
Input voltage, $V_I$ (either input)	.....	0 to 5.5 V
Duration of output short circuit (one amplifier) to ground at (or below) $T_A = 25^\circ\text{C}$ , $V_{CC} \leq 5.5$ V (see Note 3)	.....	Unlimited
Operating virtual junction temperature	.....	150°C
Package thermal impedance, $\theta_{JA}$ (see Notes 4 and 5):	D (8-pin) package	97°C/W
	D (14-pin) package	86°C/W
	D (16-pin) package	73°C/W
	DBV package	206°C/W
	DCK package	252°C/W
	DGK package	172°C/W
	PW (8-pin) package	149°C/W
	PW (14-pin) package	113°C/W
	PW (16-pin) package	108°C/W
Storage temperature range, $T_{stg}$	.....	-65 to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values (except differential voltages and  $V_{CC}$  specified for the measurement of  $I_{OS}$ ) are with respect to the network GND.  
2. Differential voltages are at IN+ with respect to IN-.  
3. Short circuits from outputs to  $V_{CC}$  can cause excessive heating and eventual destruction.  
4. Maximum power dissipation is a function of  $T_J(\text{max})$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_J(\text{max}) - T_A)/\theta_{JA}$ . Selecting the maximum of 150°C can affect reliability.  
5. The package thermal impedance is calculated in accordance with JESD 51-7.

## recommended operating conditions (see Note 6)

		MIN	MAX	UNIT
$V_{CC}$	Supply voltage (single-supply operation)	2.7	5.5	V
$V_{IH}$	Amplifier turn-on voltage level (LMV324S) <sup>‡</sup>	$V_{CC} = 2.7$ V	1.7	V
		$V_{CC} = 5$ V	3.5	
$V_{IL}$	Amplifier turn-off voltage level (LMV324S)	$V_{CC} = 2.7$ V	0.7	V
		$V_{CC} = 5$ V	1.5	
$T_A$	Operating free-air temperature	-40	85	°C

<sup>‡</sup>  $V_{IH}$  should not be allowed to exceed  $V_{CC}$ .

NOTE 6: All unused control inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



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# LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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## electrical characteristics at $T_A = 25^\circ\text{C}$ and $V_{CC+} = 2.7\text{ V}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{IO}$	Input offset voltage		1.7	7	mV
$\alpha_{V_{IO}}$	Average temperature coefficient of input offset voltage		5		$\mu\text{V}/^\circ\text{C}$
$I_{IB}$	Input bias current		11	250	nA
$I_{IO}$	Input offset current		5	50	nA
CMRR	Common-mode rejection ratio	$V_{CM} = 0$ to $1.7\text{ V}$	50	63	dB
$k_{SVR}$	Supply-voltage rejection ratio	$V_{CC} = 2.7\text{ V}$ to $5\text{ V}$ , $V_O = 1\text{ V}$	50	60	dB
$V_{ICR}$	Common-mode input voltage range	$\text{CMRR} \geq 50\text{ dB}$	0 to 1.7	-0.2 to 1.9	V
Output swing	$R_L = 10\text{ k}\Omega$ to $1.35\text{ V}$	High level	$V_{CC-100}$	$V_{CC-10}$	mV
		Low level	60	180	
$I_{CC}$	LMV321I		80	170	$\mu\text{A}$
	LMV358I (both amplifiers)		140	340	
	LMV324I/LMV324SI (all four amplifiers)		260	680	
$B_1$	Unity-gain bandwidth	$C_L = 200\text{ pF}$		1	MHz
$\Phi_m$	Phase margin			60	deg
$G_m$	Gain margin			10	dB
$V_n$	Equivalent input noise voltage	$f = 1\text{ kHz}$		46	$\text{nV}/\sqrt{\text{Hz}}$
$I_n$	Equivalent input noise current	$f = 1\text{ kHz}$		0.17	$\text{pA}/\sqrt{\text{Hz}}$

## shutdown characteristics (LMV324S) at $T_A = 25^\circ\text{C}$ and $V_{CC+} = 2.7\text{ V}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$I_{CC(SHDN)}$	Supply current in shutdown mode (per channel)	$\overline{\text{SHDN}} \leq 0.6\text{ V}$		5	$\mu\text{A}$
$t_{(\text{on})}$	Amplifier turn-on time	$A_V = 1$ , $R_L = \text{Open}$ (measured at 50% point)		2	$\mu\text{s}$
$t_{(\text{off})}$	Amplifier turn-off time	$A_V = 1$ , $R_L = \text{Open}$ (measured at 50% point)		40	ns

# LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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**electrical characteristics at specified free-air temperature range,  $V_{CC+} = 5$  V (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	$T_A$	MIN	TYP	MAX	UNIT
$V_{IO}$ Input offset voltage		25°C		1.7	7	mV
		–40°C to 85°C		9		
$\alpha_{V_{IO}}$ Average temperature coefficient of input offset voltage		25°C		5		µV/°C
$I_{IB}$ Input bias current		25°C		15	250	nA
		–40°C to 85°C		500		
$I_{IO}$ Input offset current		25°C		5	50	nA
		–40°C to 85°C		150		
CMRR Common-mode rejection ratio	$V_{CM} = 0$ to 4 V	25°C	50	65		dB
kSVR Supply-voltage rejection ratio	$V_{CC} = 2.7$ V to 5 V, $V_O = 1$ V, $V_{CM} = 1$ V	25°C	50	60		dB
$V_{ICR}$ Common-mode input voltage range	$CMMR \geq 50$ dB	25°C	0 to 4	–0.2 to 4.2		V
Output swing	$R_L = 2$ kΩ to 2.5 V	High level	25°C	$V_{CC}–300$	$V_{CC}–40$	mV
			–40°C to 85°C	$V_{CC}–400$		
		Low level	25°C		120 300	
			–40°C to 85°C		400	
	$R_L = 10$ kΩ to 2.5 V	High level	25°C	$V_{CC}–100$	$V_{CC}–10$	
			–40°C to 85°C	$V_{CC}–200$		
		Low level	25°C		65 180	
			–40°C to 85°C		280	
AvD Large-signal differential voltage gain	$R_L = 2$ kΩ	25°C	15	100		V/mV
		–40°C to 85°C	10			
$I_{OS}$ Output short-circuit current	Sourcing, $V_O = 0$ V	25°C	5	60		mA
	Sinking, $V_O = 5$ V		10	160		
$I_{CC}$ Supply current	LMV321I	25°C		130	250	µA
		–40°C to 85°C		350		
	LMV358I (both amplifiers)	25°C		210	440	µA
		–40°C to 85°C		615		
	LMV324I/LMV324SI (all four amplifiers)	25°C		410	830	µA
		–40°C to 85°C		1160		
B <sub>1</sub> Unity-gain bandwidth	$C_L = 200$ pF	25°C		1		MHz
$\phi_m$ Phase margin		25°C		60		deg
G <sub>m</sub> Gain margin		25°C		10		dB
V <sub>n</sub> Equivalent input noise voltage	f = 1 kHz	25°C		39		nV/√Hz
I <sub>n</sub> Equivalent input noise current	f = 1 kHz	25°C		0.21		pA/√Hz
SR Slew rate		25°C		1		V/µs

**shutdown characteristics (LMV324S) at  $T_A = 25^\circ\text{C}$  and  $V_{CC+} = 5$  V (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	$T_A$	MIN	TYP	MAX	UNIT
$I_{CC(SHDN)}$ Supply current in shutdown mode (per channel)	$\overline{SHDN} \leq 0.6$ V	–40°C to 85°C		5		µA
t <sub>(on)</sub> Amplifier turn-on time	$A_V = 1$ , $R_L = \text{Open}$ (measured at 50% point)		2			µs
t <sub>(off)</sub> Amplifier turn-off time	$A_V = 1$ , $R_L = \text{Open}$ (measured at 50% point)		40			ns



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## TYPICAL CHARACTERISTICS

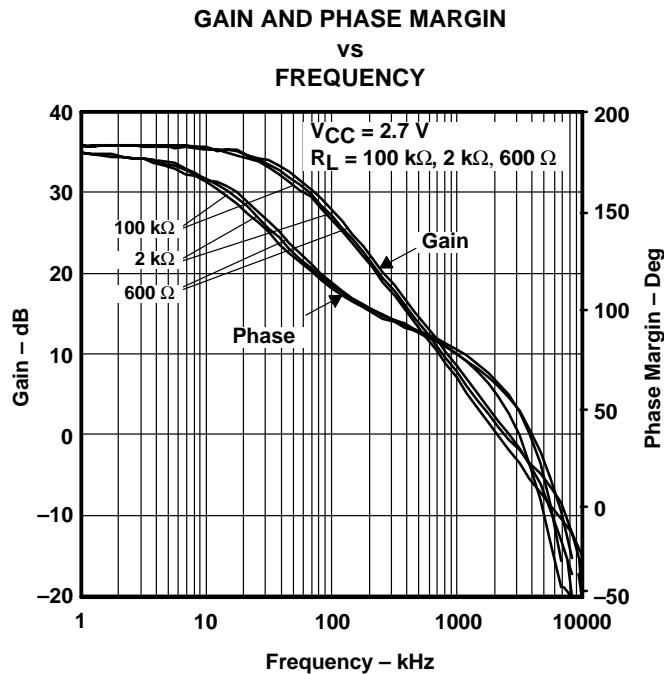


Figure 1

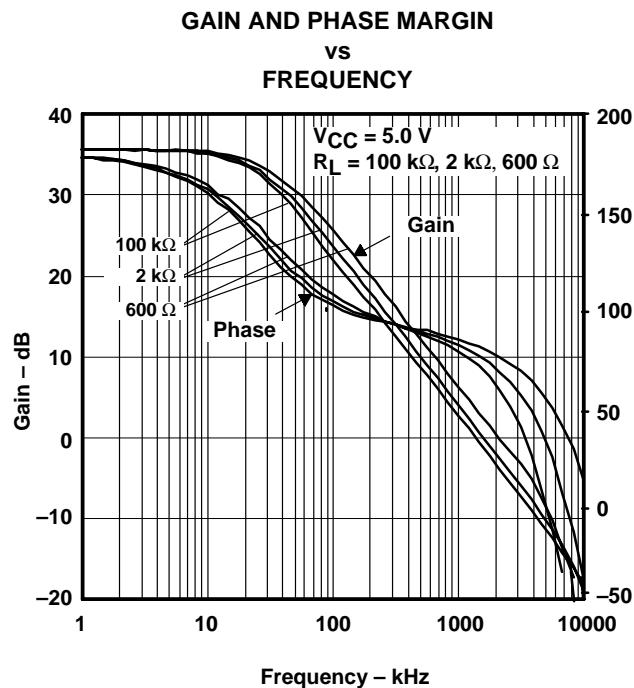


Figure 2

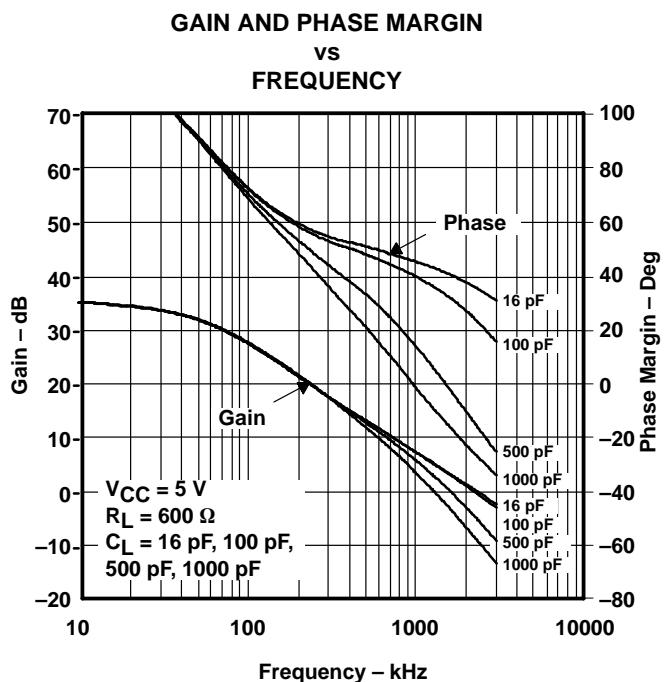


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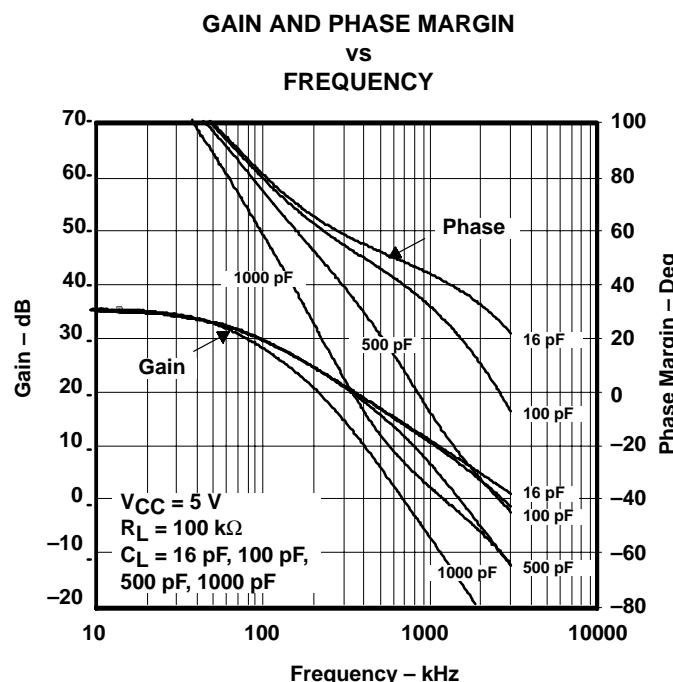


Figure 4

# LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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## TYPICAL CHARACTERISTICS

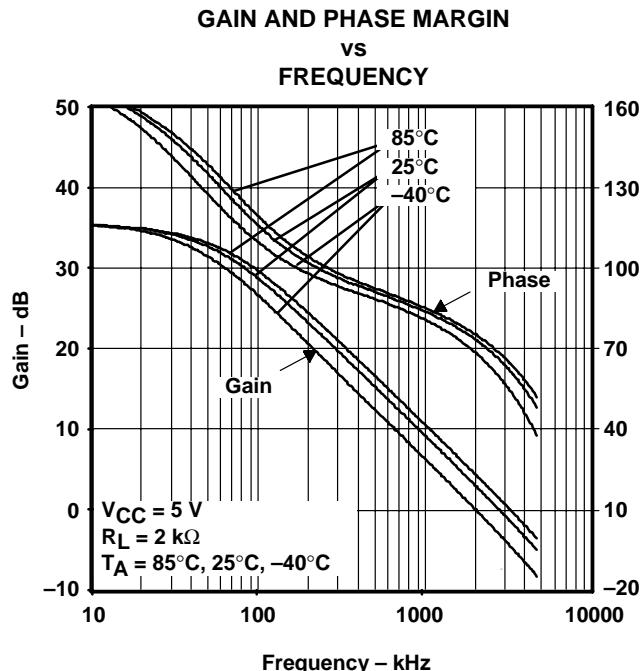


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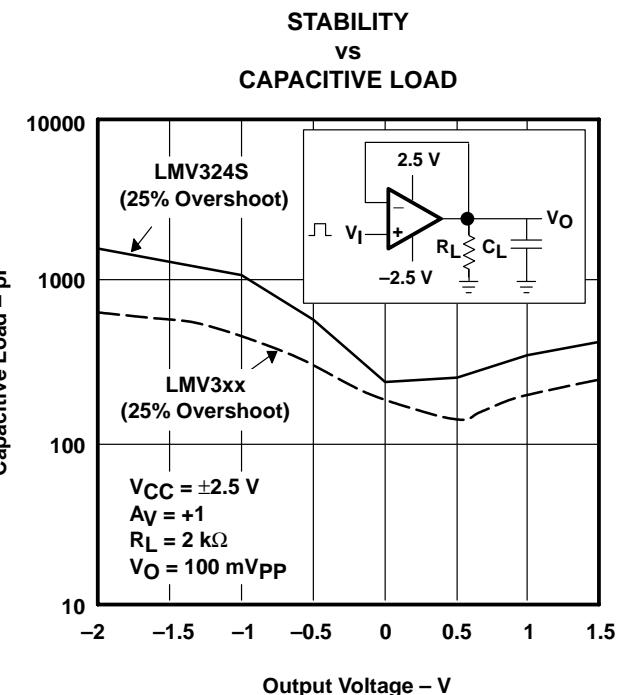


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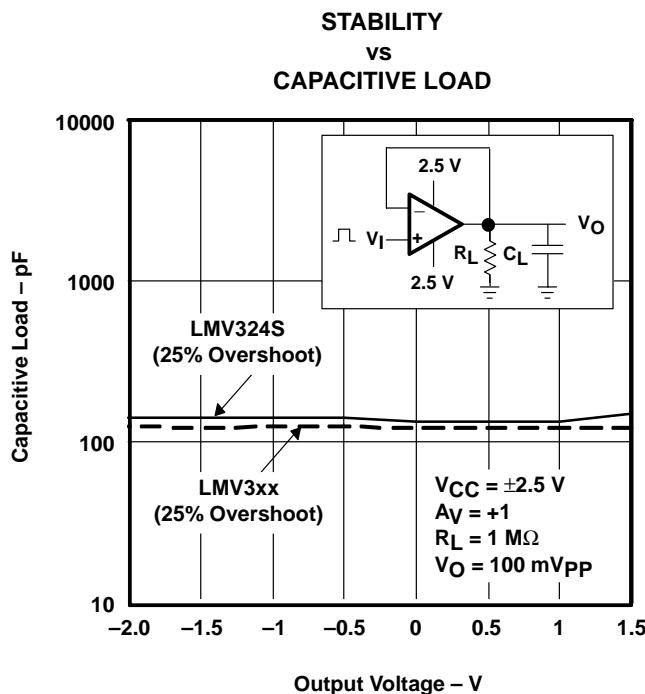


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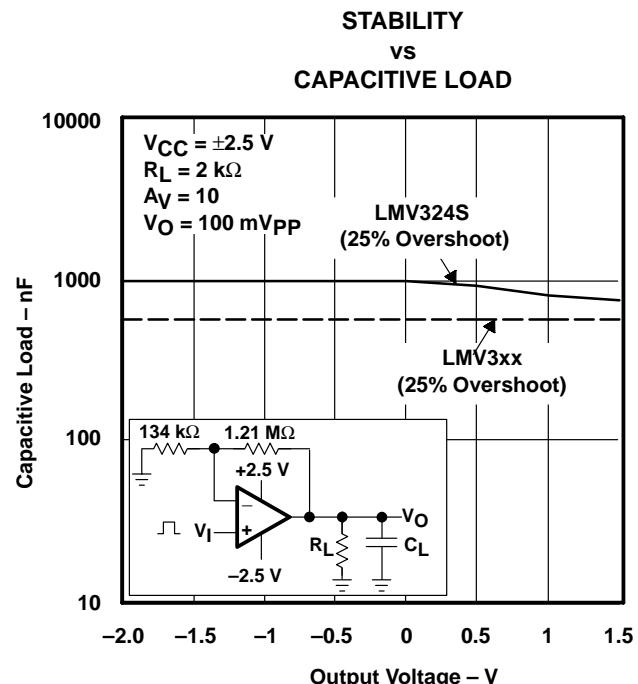


Figure 8

# LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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## TYPICAL CHARACTERISTICS

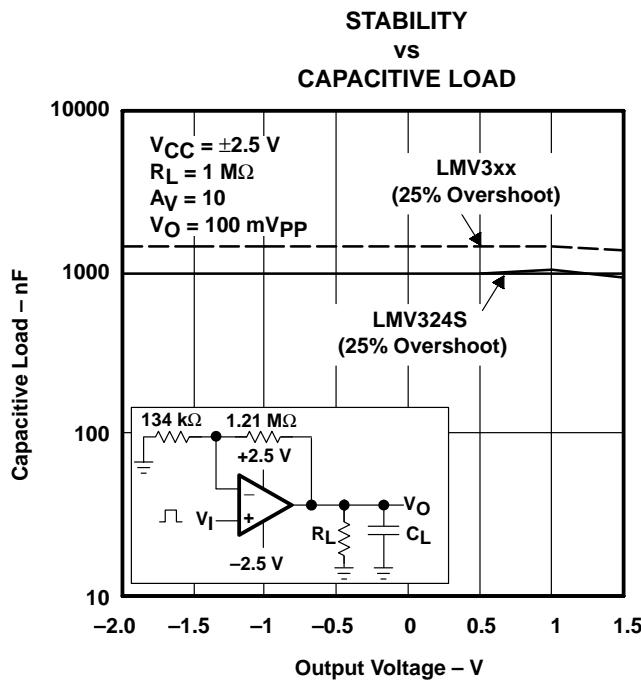


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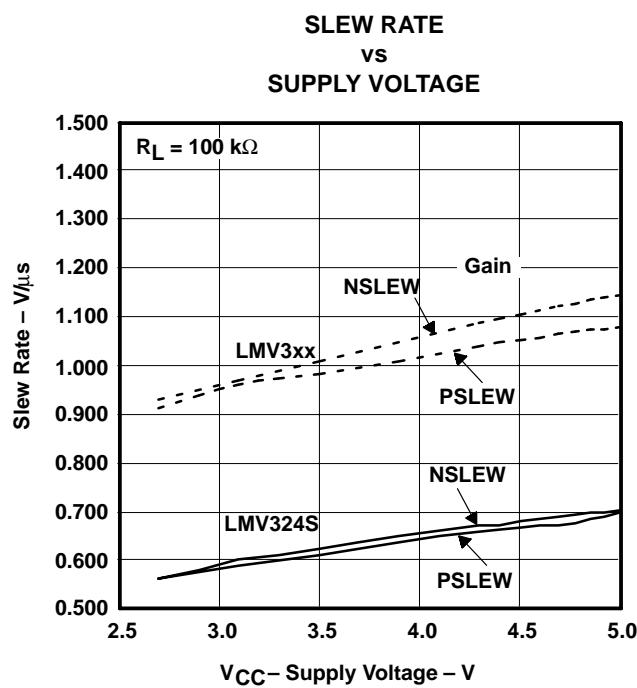


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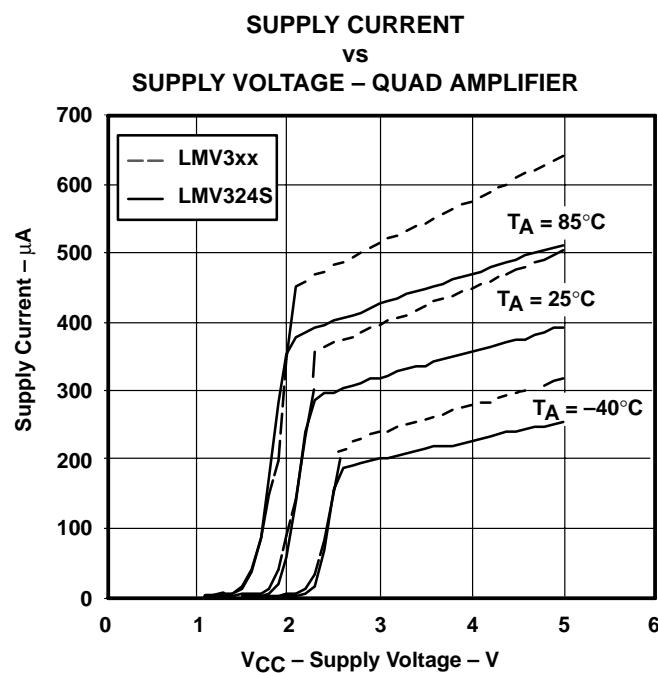


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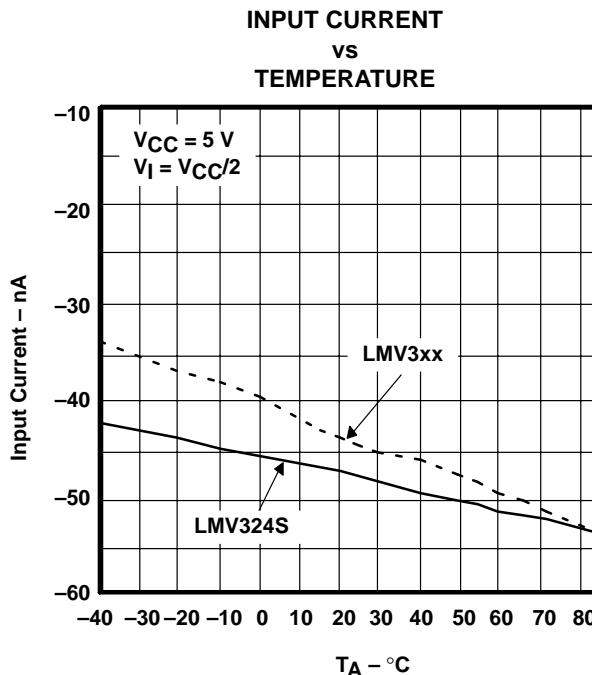


Figure 12

# LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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## TYPICAL CHARACTERISTICS

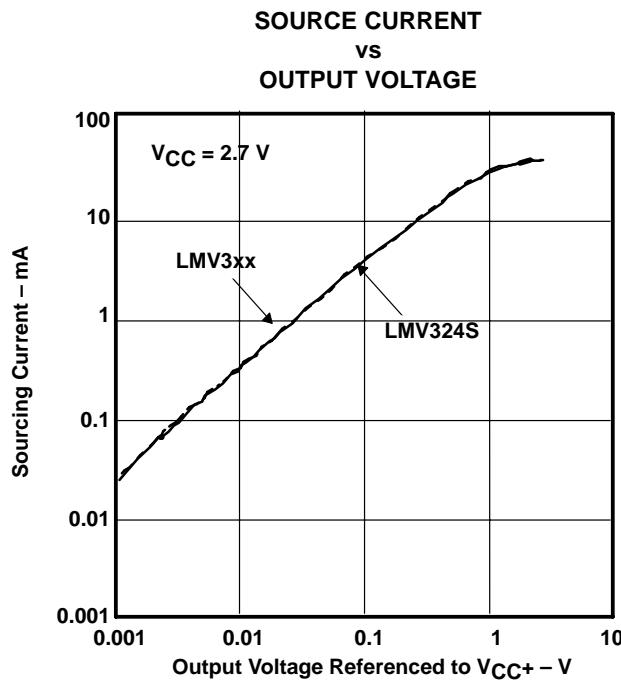


Figure 13

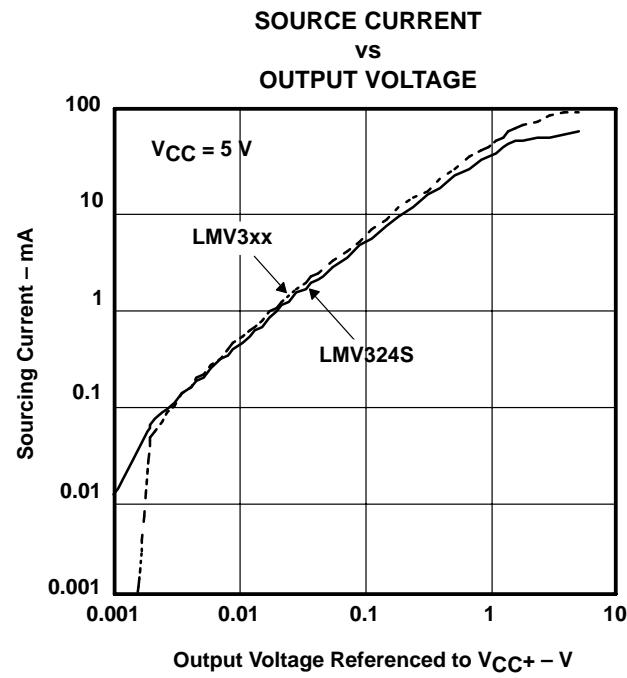


Figure 14

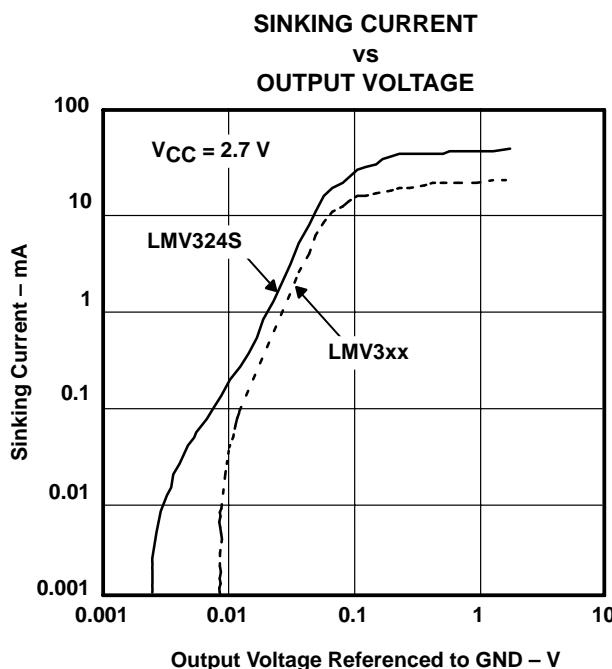


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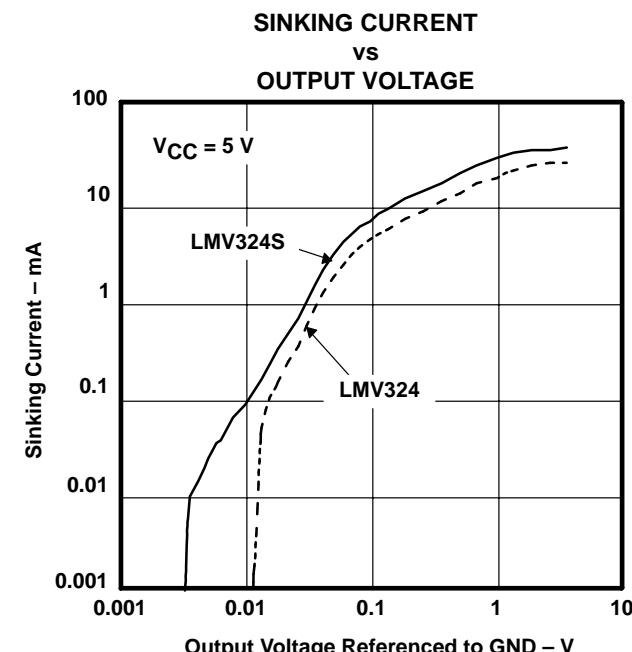


Figure 16

# LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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## TYPICAL CHARACTERISTICS

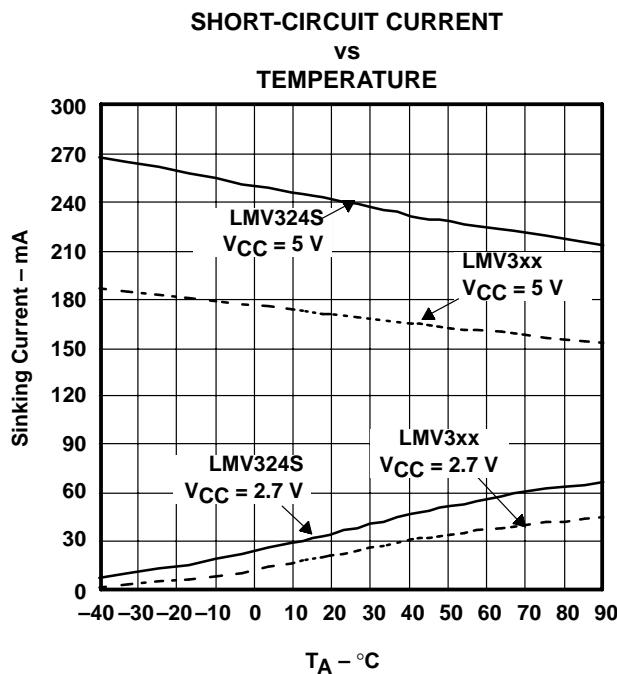


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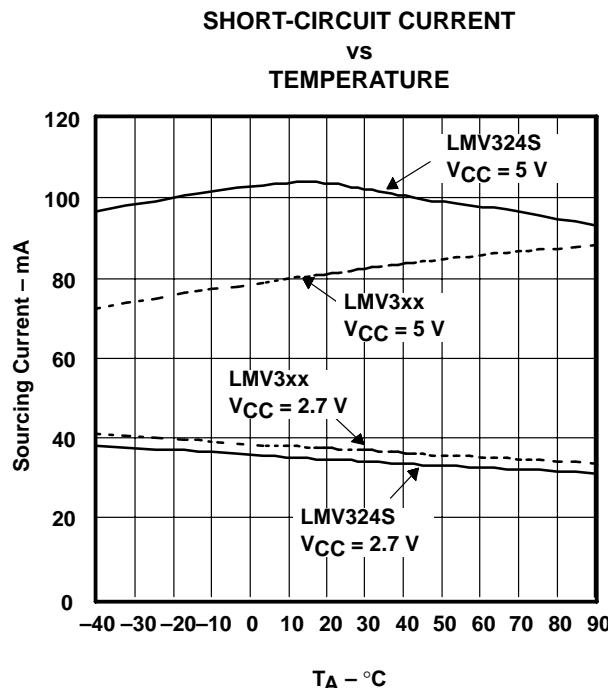


Figure 18

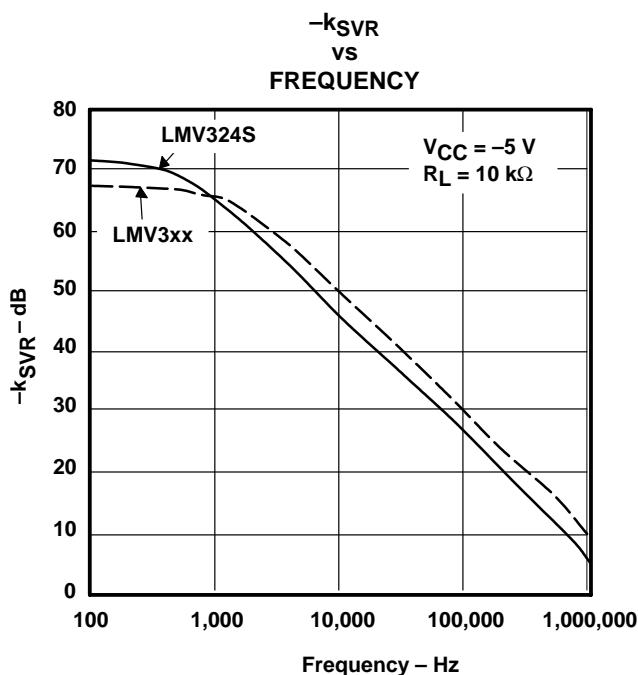


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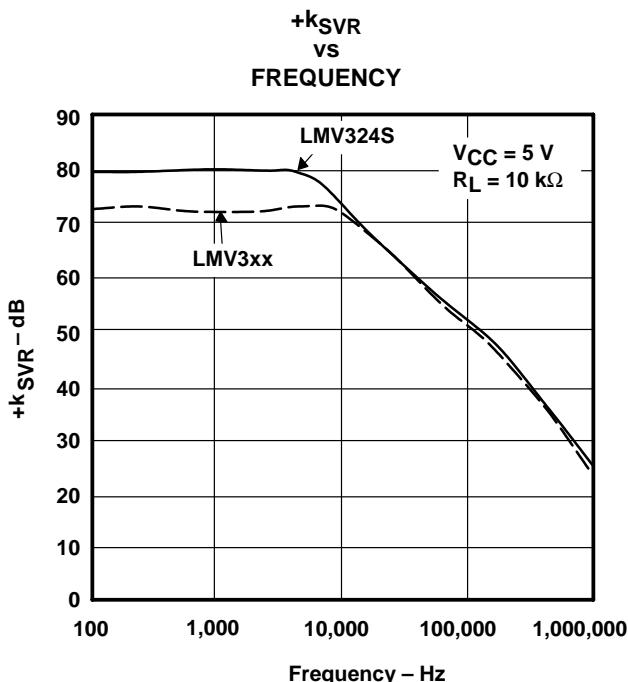


Figure 20

# LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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## TYPICAL CHARACTERISTICS

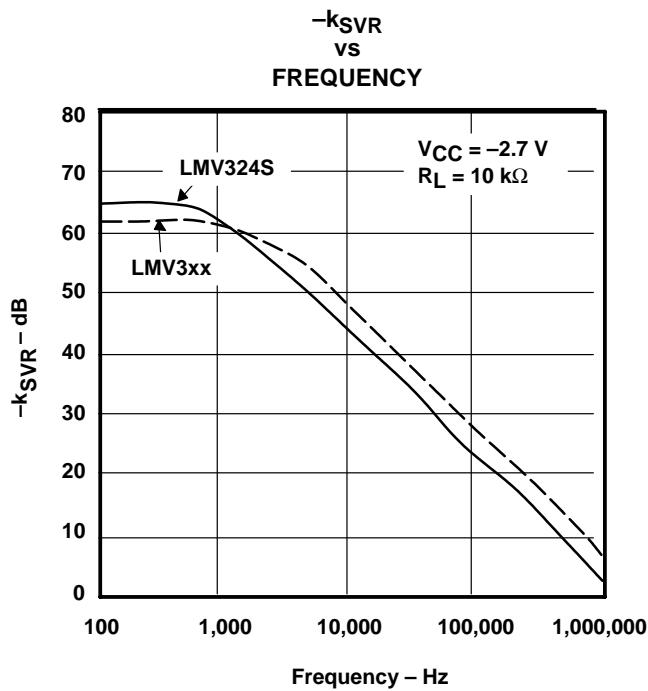


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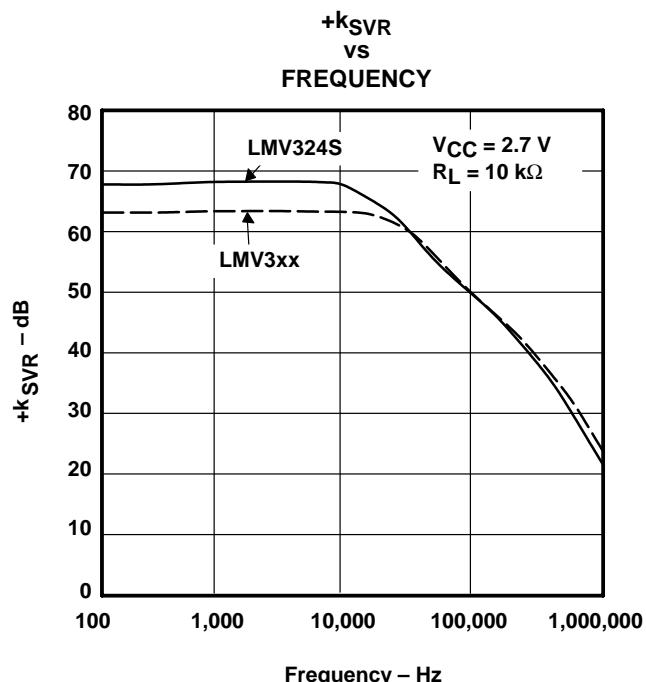


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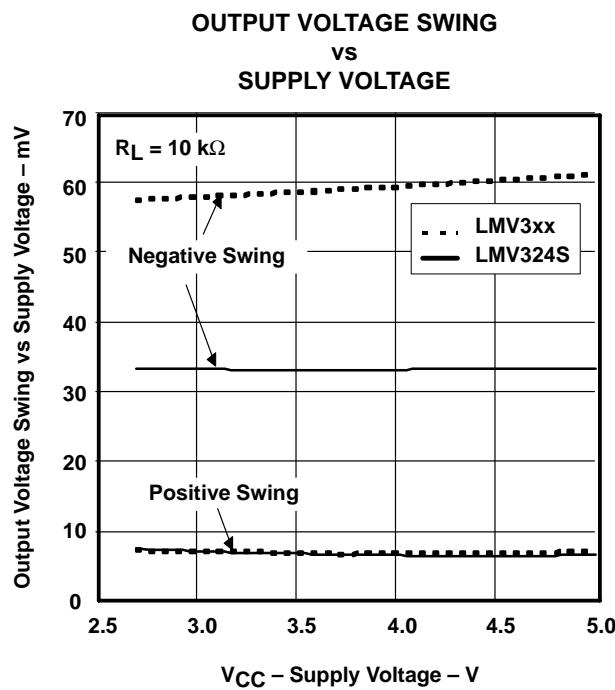


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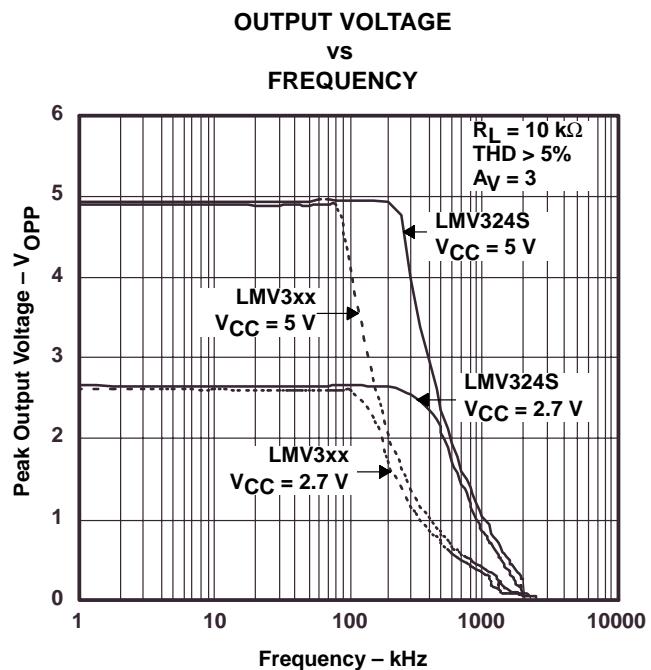


Figure 24

# LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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## TYPICAL CHARACTERISTICS

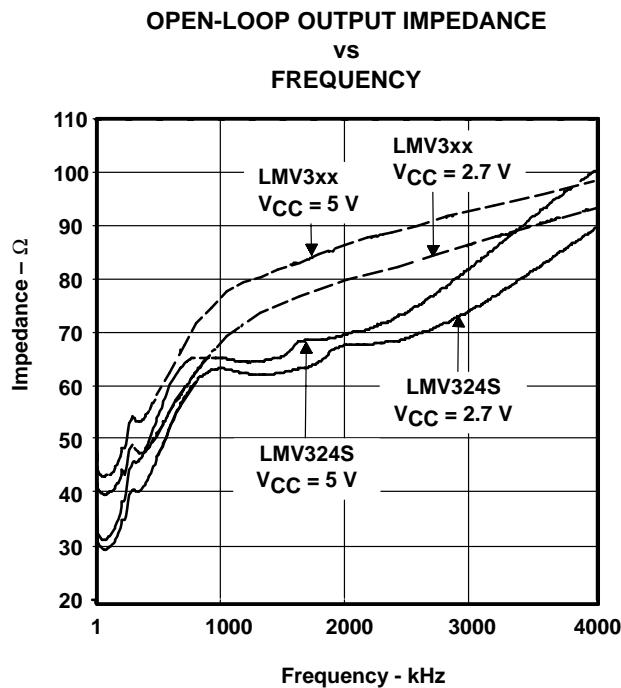


Figure 25

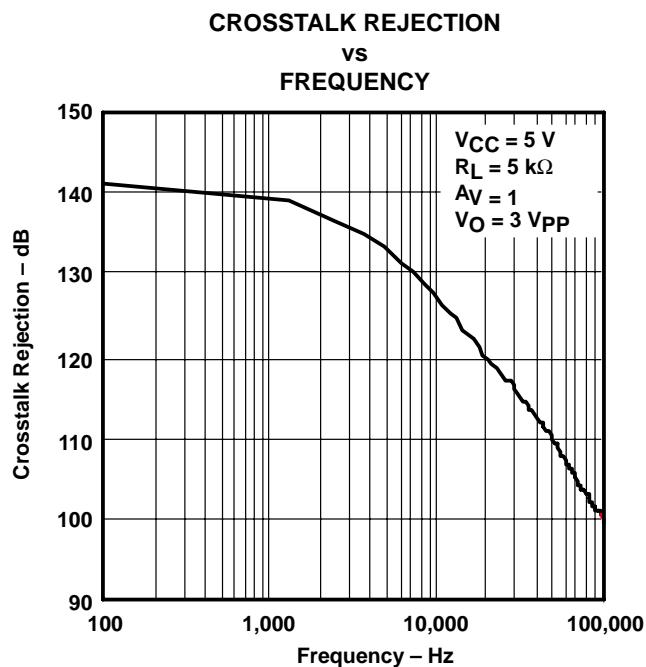


Figure 26

# LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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## TYPICAL CHARACTERISTICS

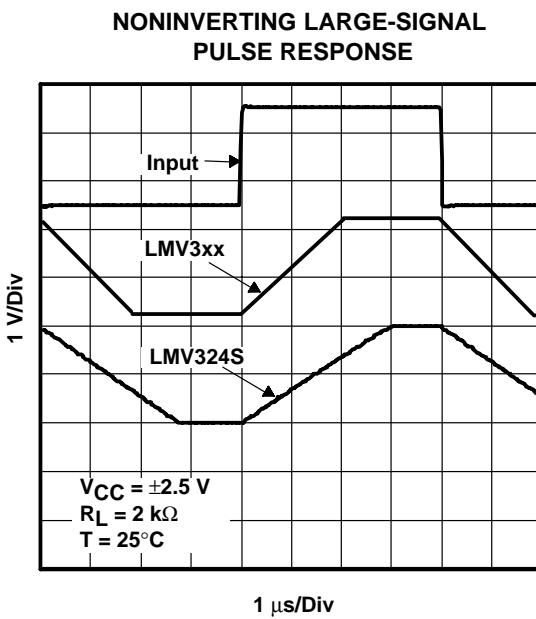


Figure 27

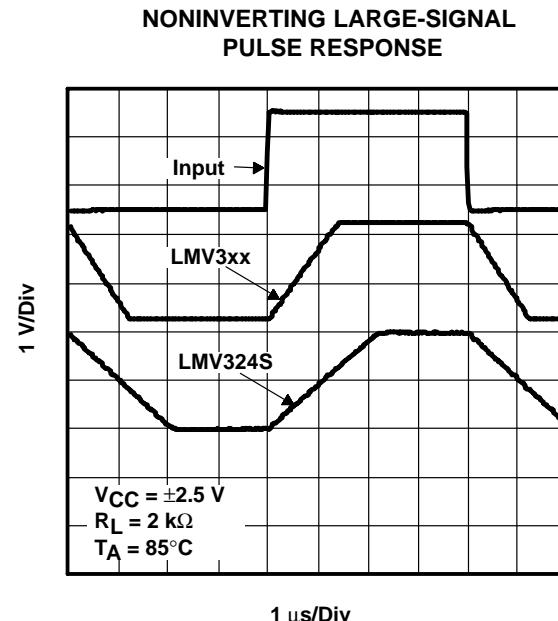


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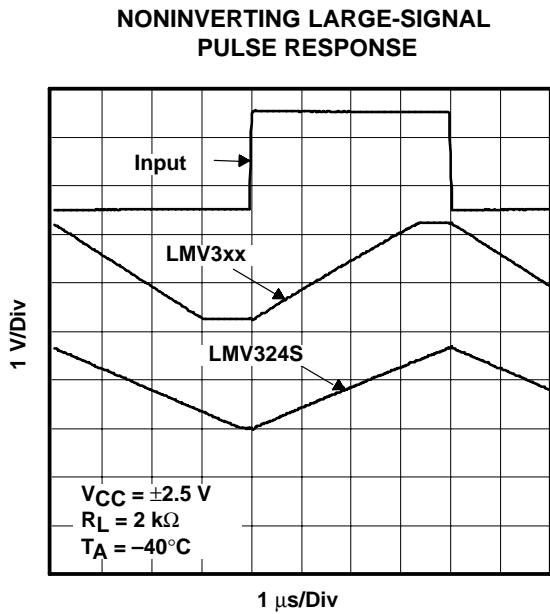


Figure 29

# LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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## TYPICAL CHARACTERISTICS

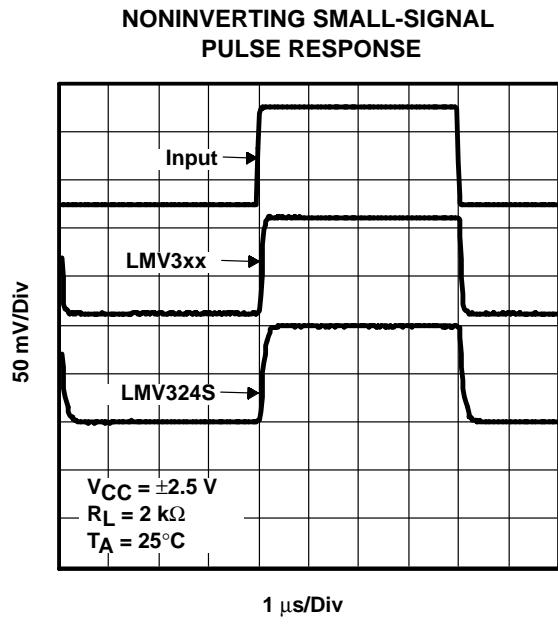


Figure 30

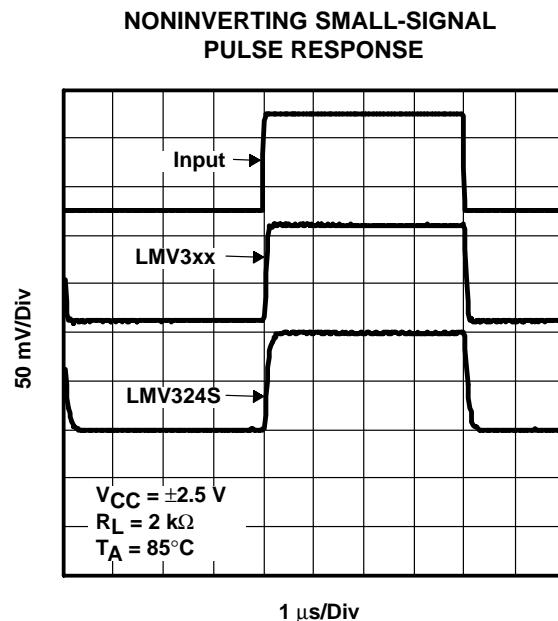


Figure 31

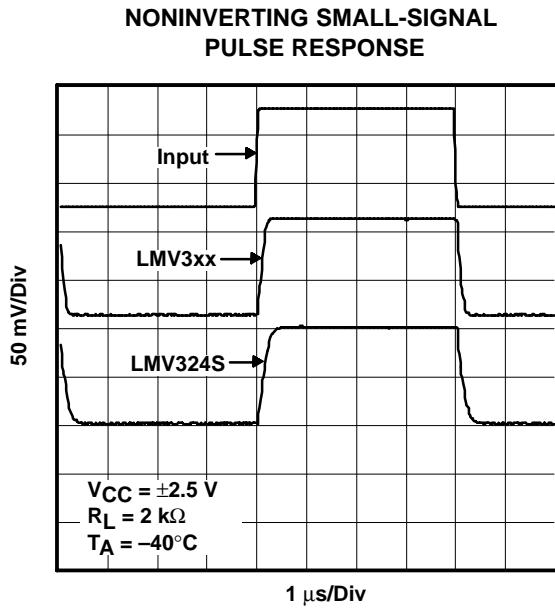


Figure 32

# LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

SLOS263G – AUGUST 1999 – REVISED NOVEMBER 2002

## TYPICAL CHARACTERISTICS

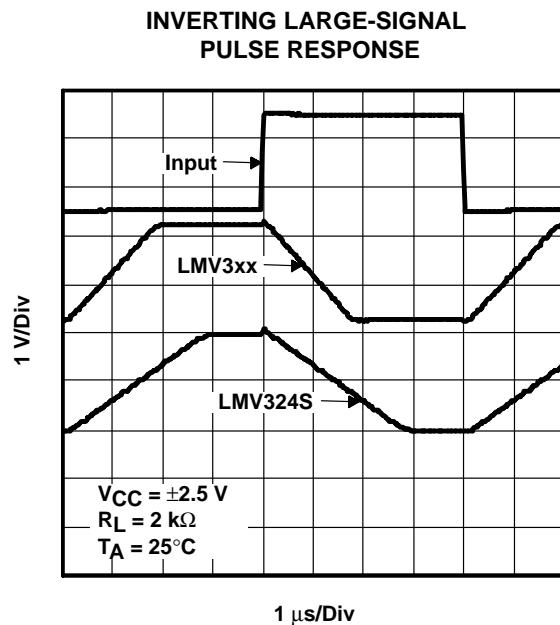


Figure 33

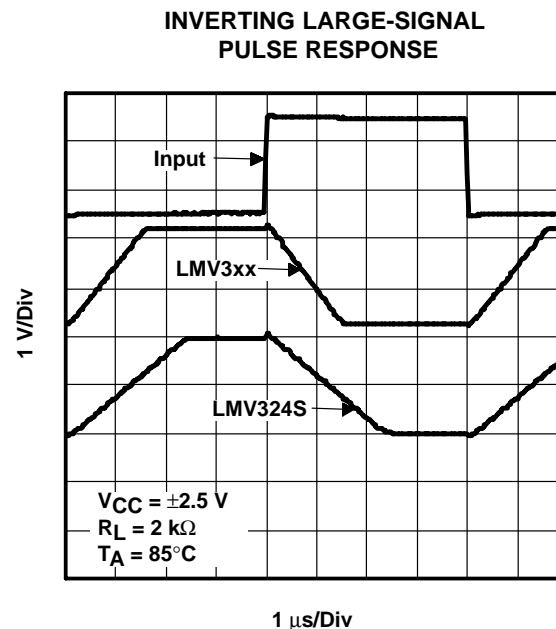


Figure 34

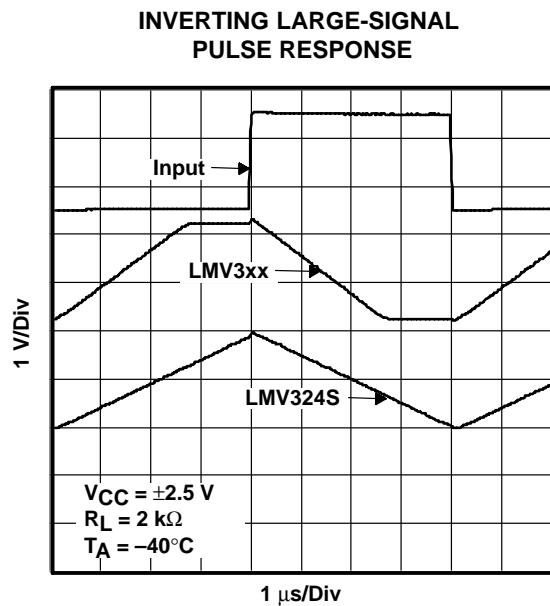


Figure 35

# LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

SLOS263G – AUGUST 1999 – REVISED NOVEMBER 2002

## TYPICAL CHARACTERISTICS

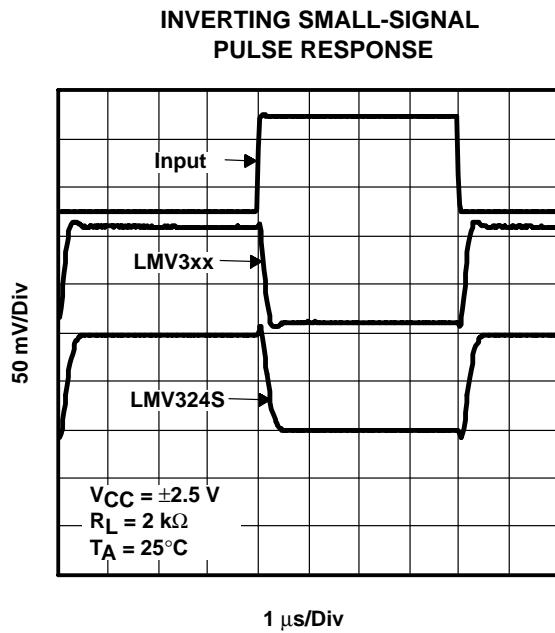


Figure 36

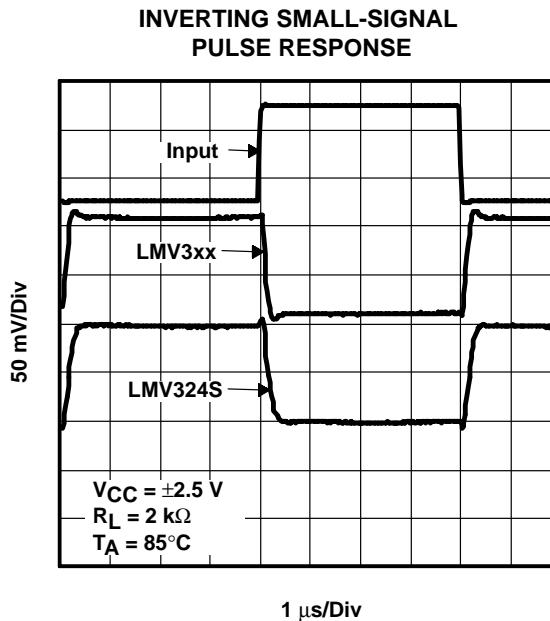


Figure 37

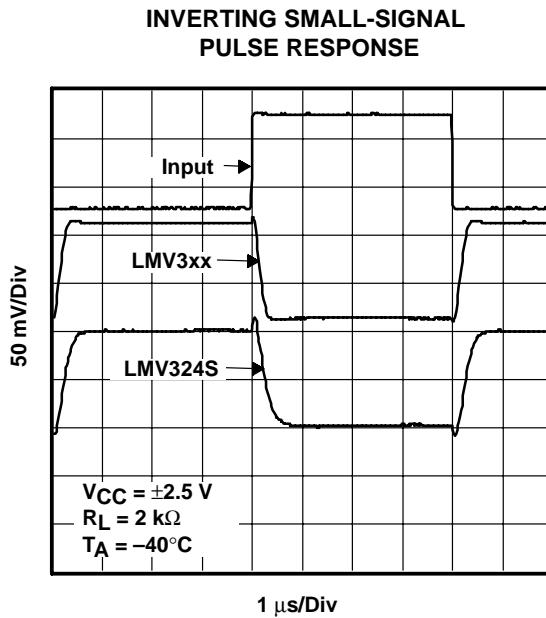


Figure 38

# LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

SLOS263G – AUGUST 1999 – REVISED NOVEMBER 2002

## TYPICAL CHARACTERISTICS

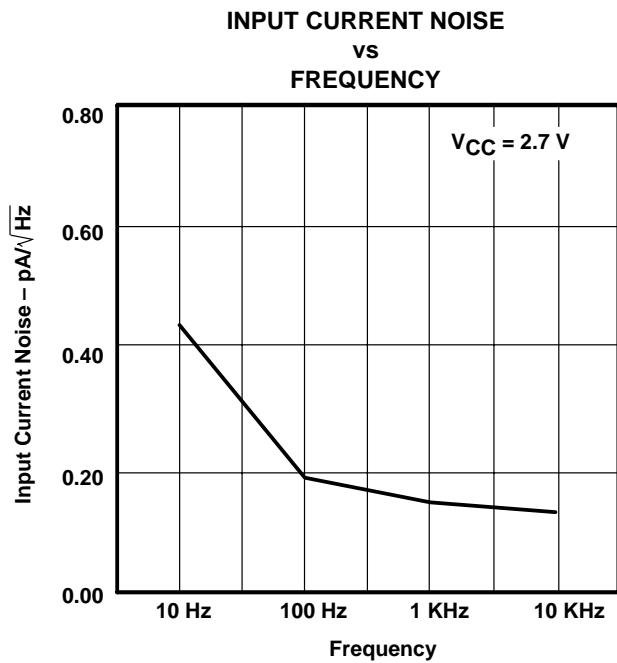


Figure 39

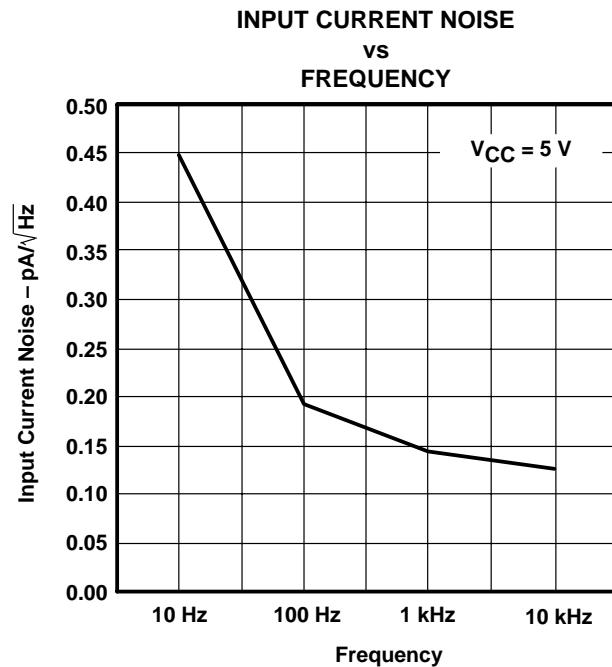


Figure 40

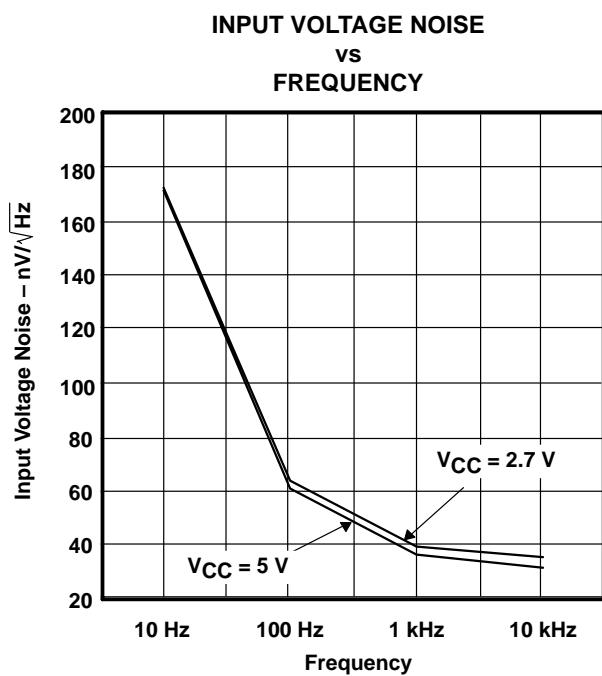


Figure 41

# LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD, LMV324S QUAD WITH SHUTDOWN LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

SLOS263G – AUGUST 1999 – REVISED NOVEMBER 2002

## TYPICAL CHARACTERISTICS

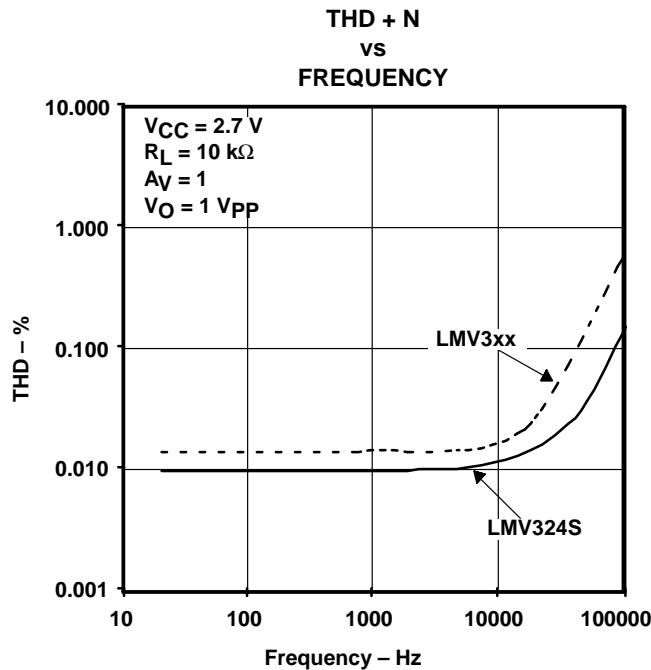


Figure 42

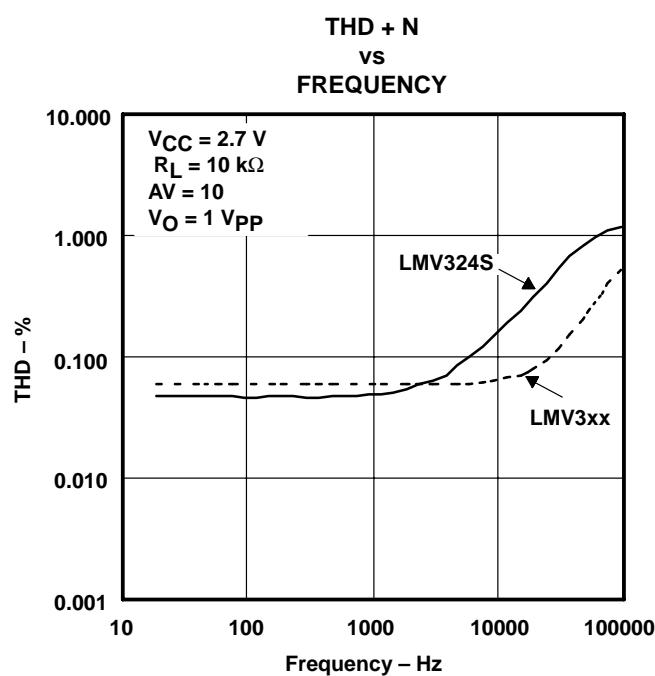


Figure 43

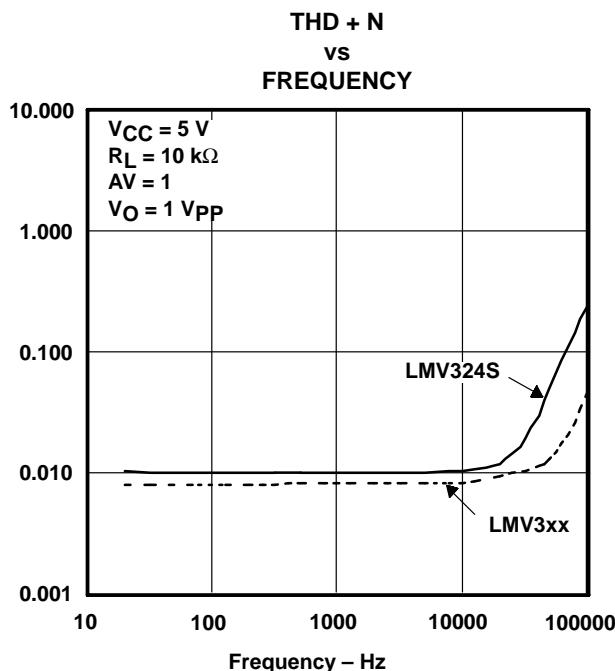


Figure 44

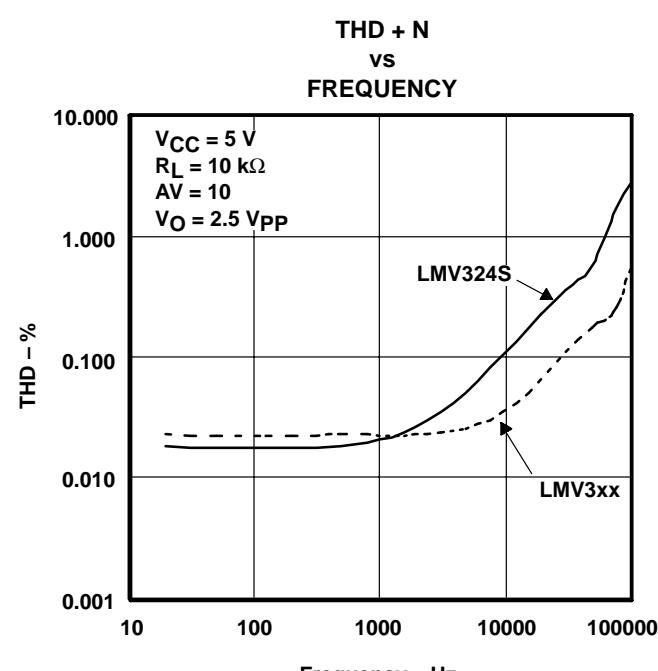
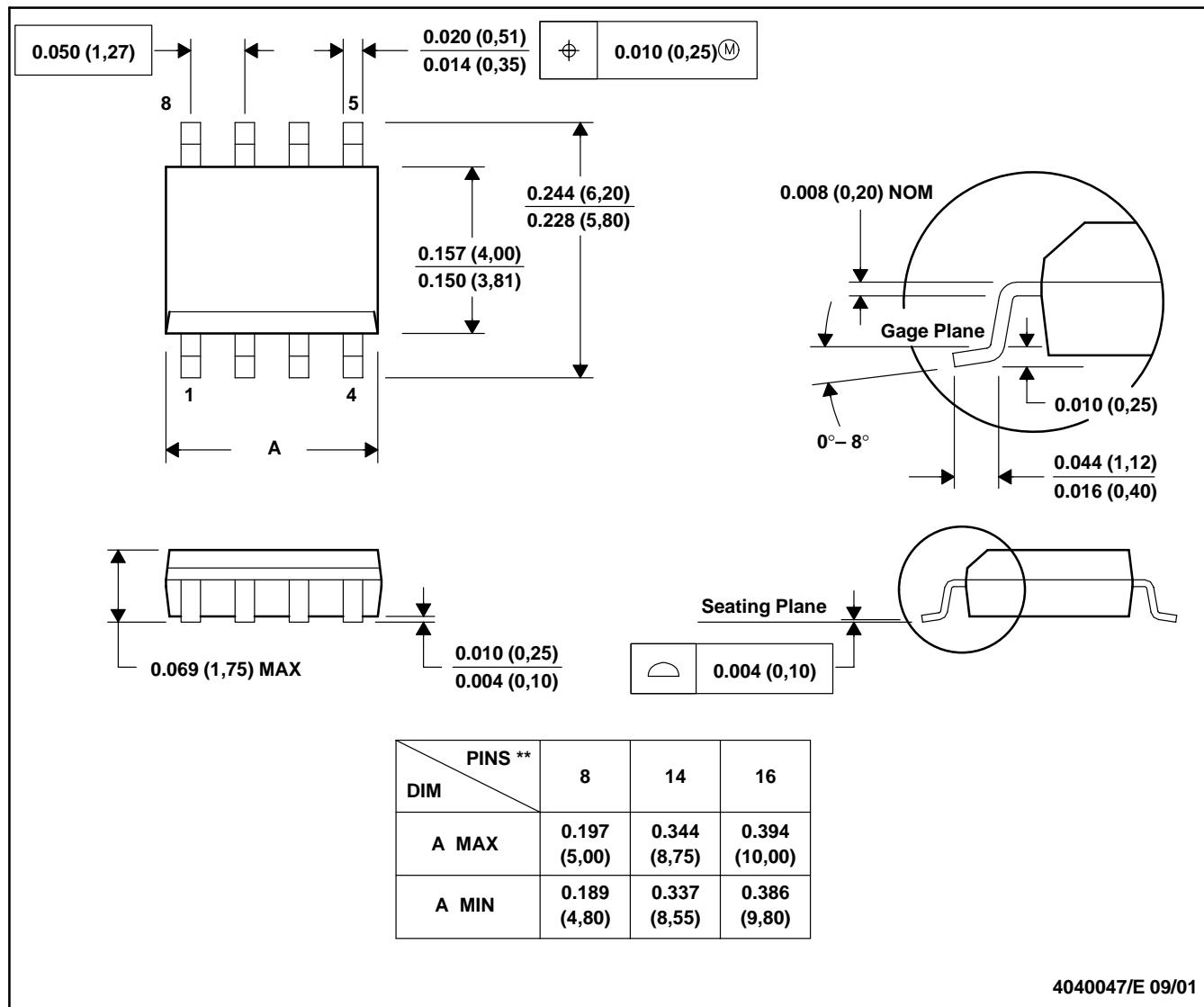


Figure 45

## D (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN



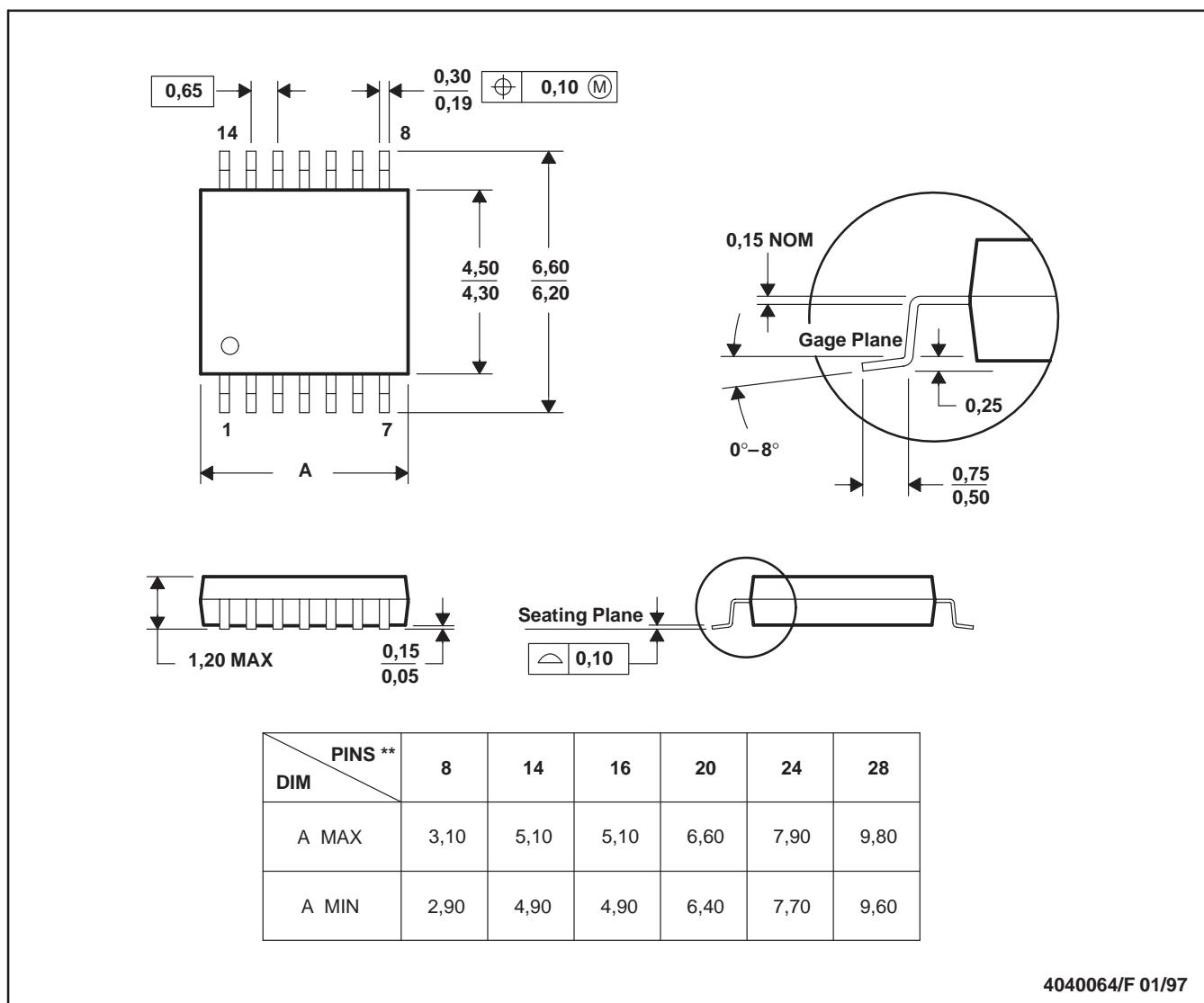
4040047/E 09/01

- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0.15).  
 D. Falls within JEDEC MS-012

## PW (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

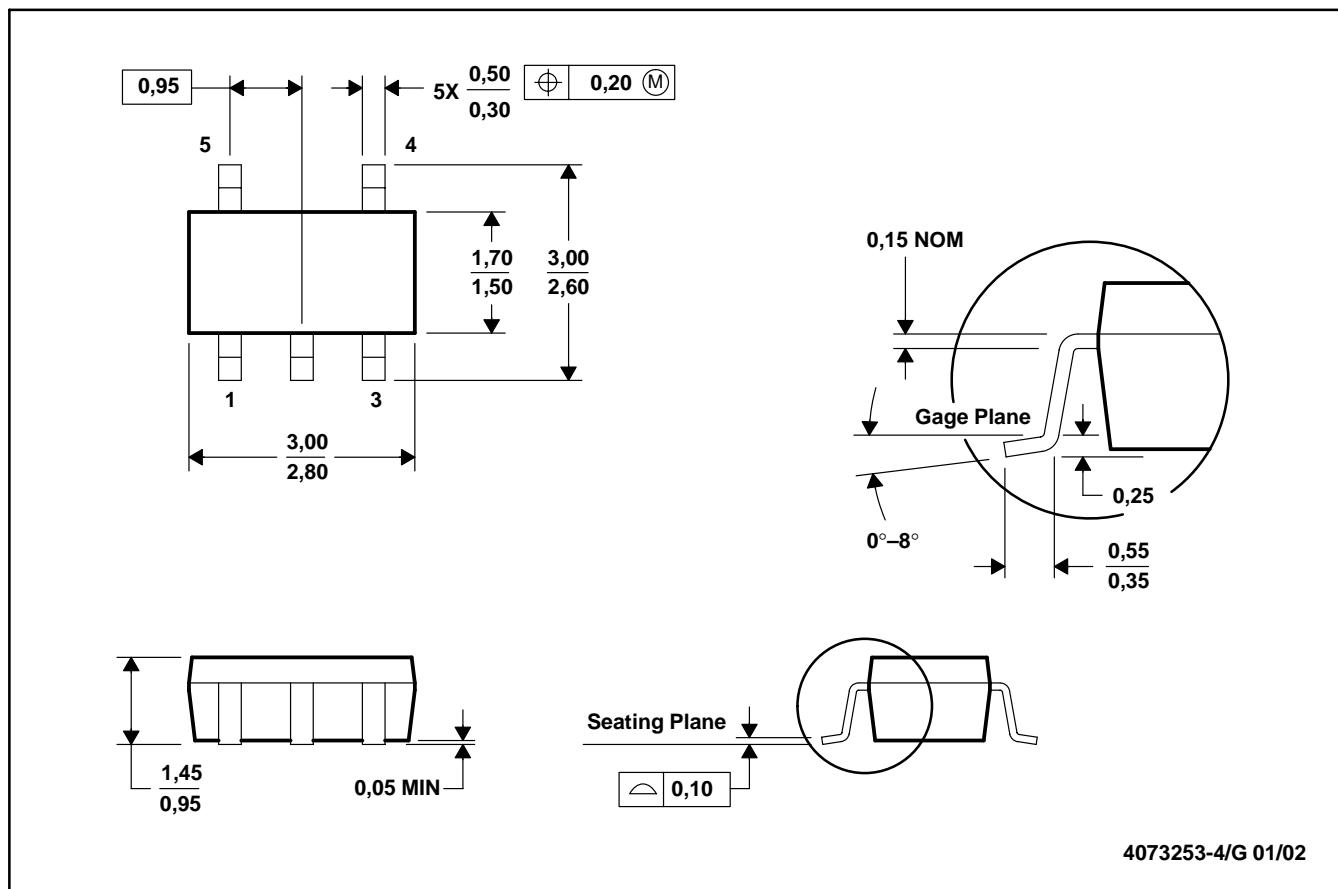
14 PINS SHOWN



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion not to exceed 0,15.
  - Falls within JEDEC MO-153

DBV (R-PDSO-G5)

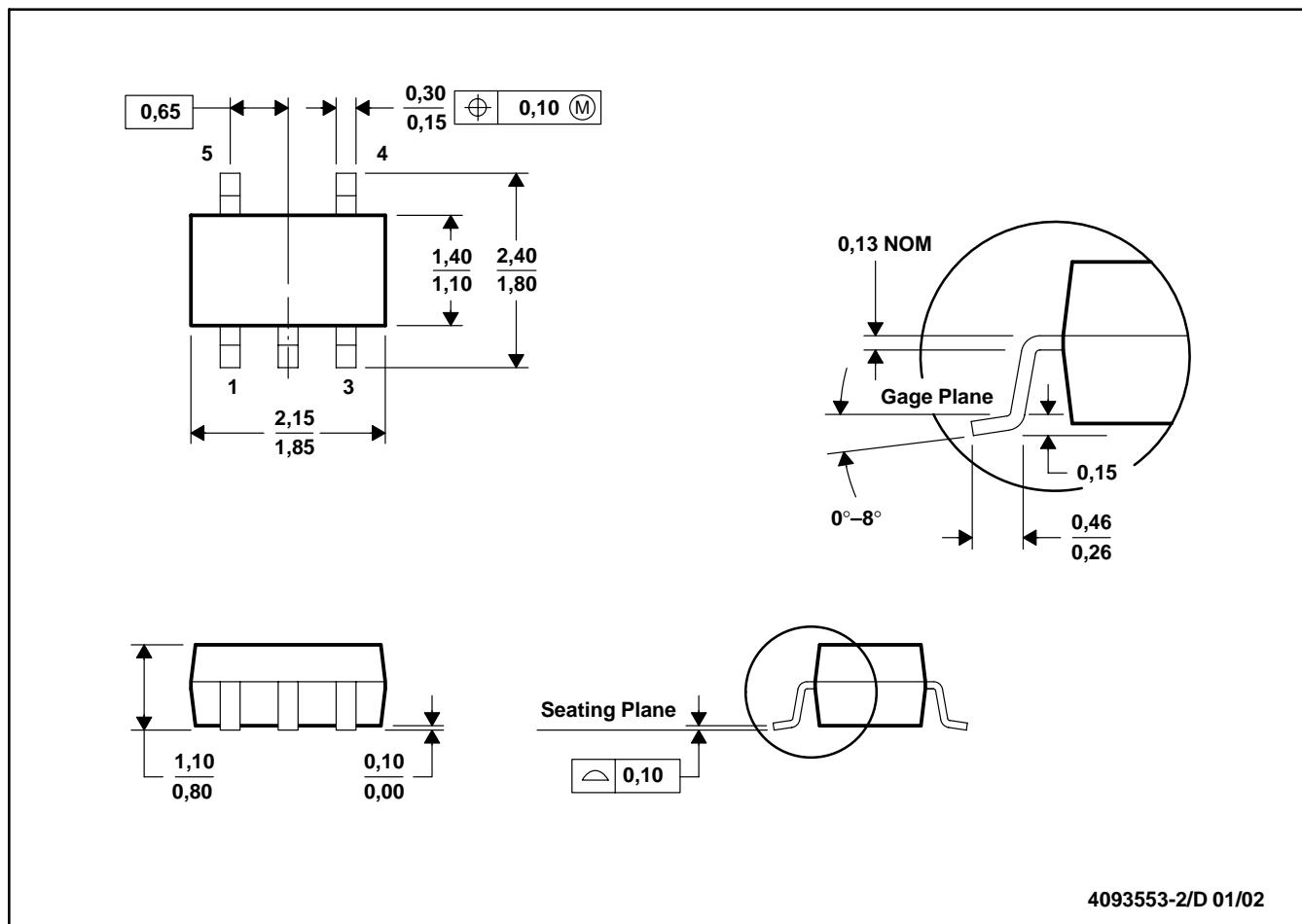
PLASTIC SMALL-OUTLINE



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion.
  - Falls within JEDEC MO-178

## DCK (R-PDSO-G5)

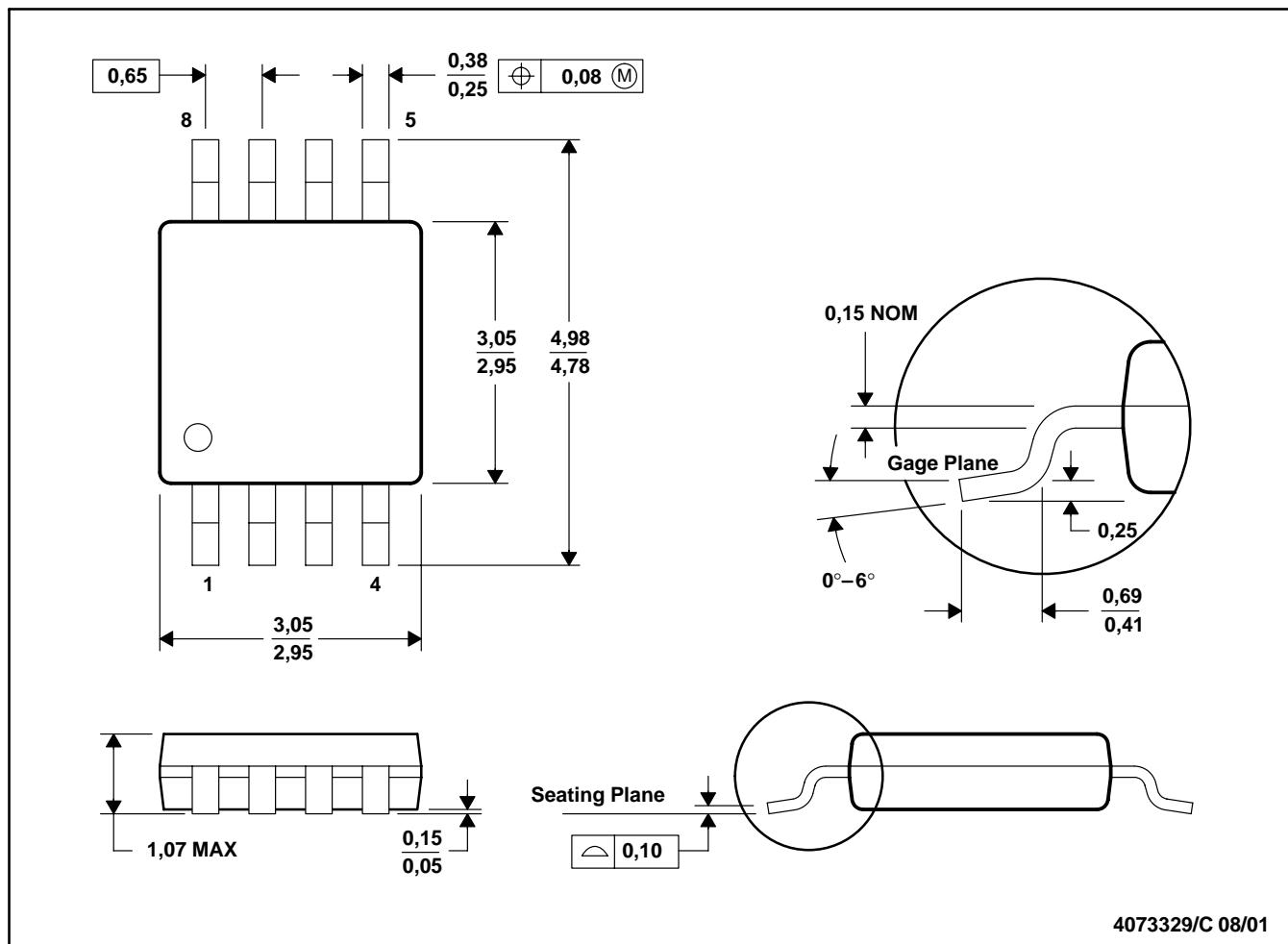
## PLASTIC SMALL-OUTLINE PACKAGE



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion.  
 D. Falls within JEDEC MO-203

DGK (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion.  
 D. Falls within JEDEC MO-187

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